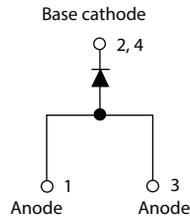
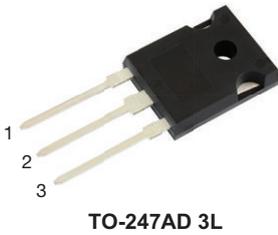


Hyperfast Rectifier, 75 A FRED Pt® G5



FEATURES

- Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off
- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- AEC-Q101 qualified meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|--------------------------|-------------|
| $I_{F(AV)}$ | 75 A |
| V_R | 600 V |
| V_F at I_F at 125 °C | 1.2 V |
| t_{rr} (typ.) | 32 |
| I_{FSM} | 650 |
| T_J max. | 175 °C |
| Package | TO-247AD 3L |
| Circuit configuration | Single |

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating

Terminal: matte tin plated leads, solderable per J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | |
|--|----------------|--|-------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Repetitive peak reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_C = 113\text{ °C}$, $D = 0.50$ | 75 | A |
| Non-repetitive peak surge current | I_{FSM} | $T_C = 25\text{ °C}$, $t_p = 10\text{ ms}$, sine wave both anodes, (1) and (3) connected | 650 | |
| Repetitive peak forward current | I_{FRM} | $T_C = 113\text{ °C}$, $D = 0.50$, $f = 20\text{ kHz}$ | 150 | |
| Operating junction and storage temperature | T_J, T_{Stg} | | -55 to +175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified) | | | | | | |
|--|---------------|---|------|------|------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 100\text{ }\mu\text{A}$ | 600 | - | - | V |
| Forward voltage | V_F | $I_F = 75\text{ A}$ | - | 1.3 | 1.7 | |
| | | $I_F = 75\text{ A}$, $T_J = 125\text{ °C}$ | - | 1.2 | - | |
| Reverse leakage current | I_R | $V_R = V_R$ rated | - | - | 25 | μA |
| | | $T_J = 125\text{ °C}$, $V_R = V_R$ rated | - | - | 500 | |
| Junction capacitance | C_T | $V_R = 200\text{ V}$ | - | 96 | - | pF |
| Series inductance | L_S | Measured to lead 5 mm from package body | - | 8 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | | | | |
|--|-----------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t_{rr} | $I_F = 1.0\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 32 | - | ns |
| | | $T_J = 25\text{ }^\circ\text{C}$ | - | 52 | - | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 82 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^\circ\text{C}$ | - | 24 | - | A |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 51 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 805 | - | nC |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 2515 | - | |
| Reverse recovery time | t_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 57 | - | ns |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 90 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^\circ\text{C}$ | - | 28 | - | A |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 58 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 969 | - | nC |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 3090 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-------------------|------------------------|------------|------|------------|---------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Thermal resistance, junction-to-case | R_{thJC} | | - | - | 0.5 | $^\circ\text{C}/\text{W}$ |
| Weight | | | - | 5.5 | - | g |
| Mounting torque | | | 6 (5) | - | 12 (10) | kgf · cm (lbf · in) |
| Maximum junction and storage temperature range | T_J , T_{Stg} | | -55 | - | 175 | $^\circ\text{C}$ |
| Marking device | | Case style TO-247AD 3L | A5PH7506LH | | | |

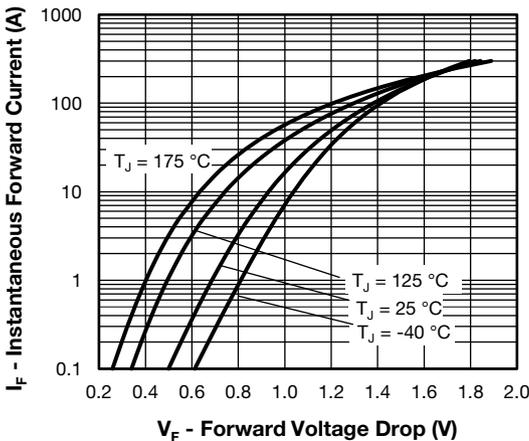


Fig. 1 - Forward Voltage Drop Characteristics

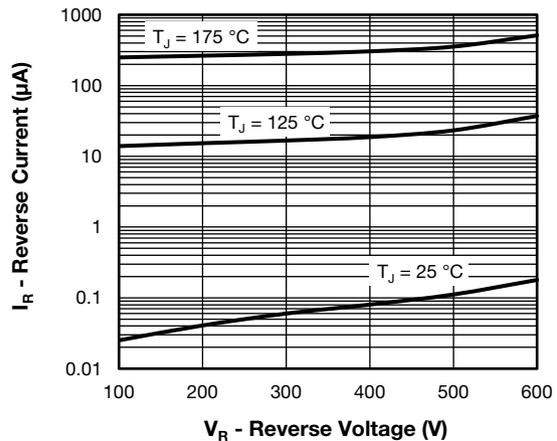


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

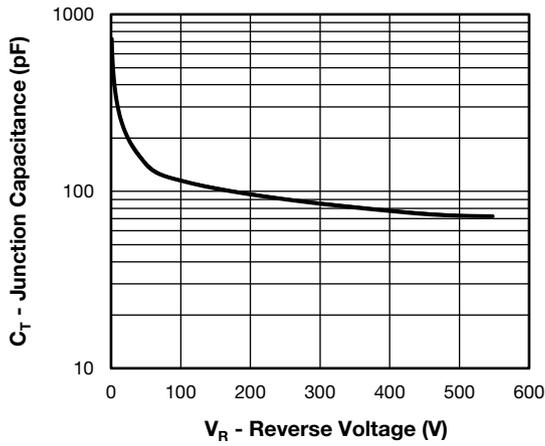


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

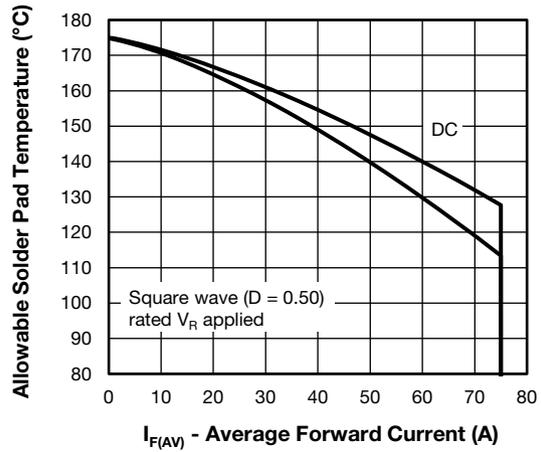


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

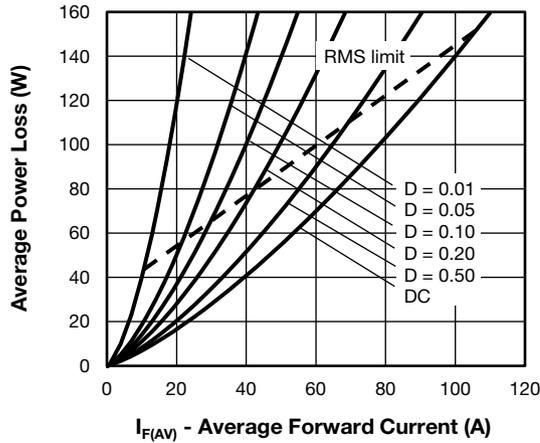


Fig. 5 - Forward Power Loss Characteristics

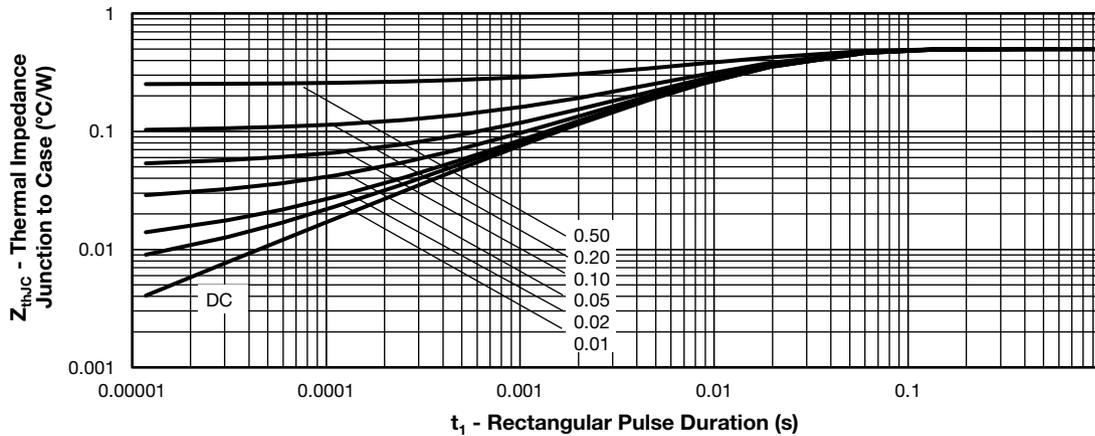


Fig. 6 - Transient Thermal Impedance, Junction to Case

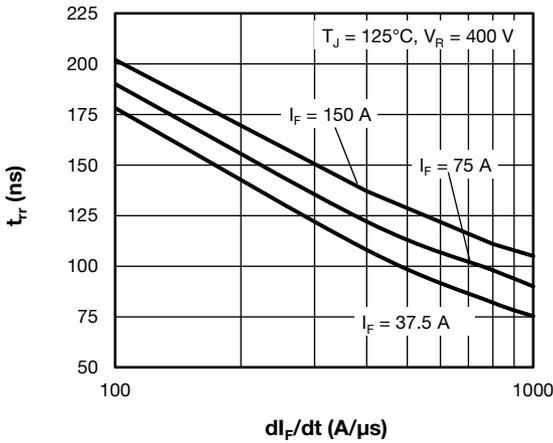


Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

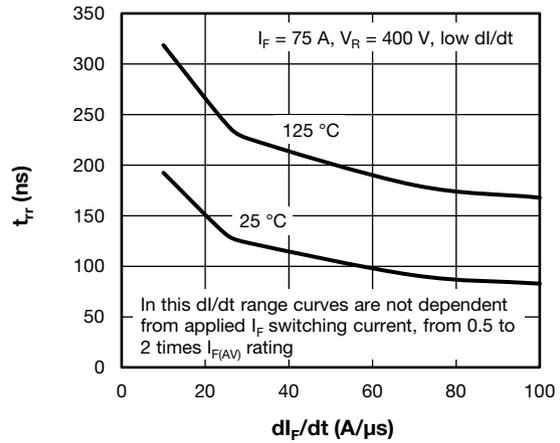


Fig. 10 - Typical Reverse Recovery Time vs. di_F/dt

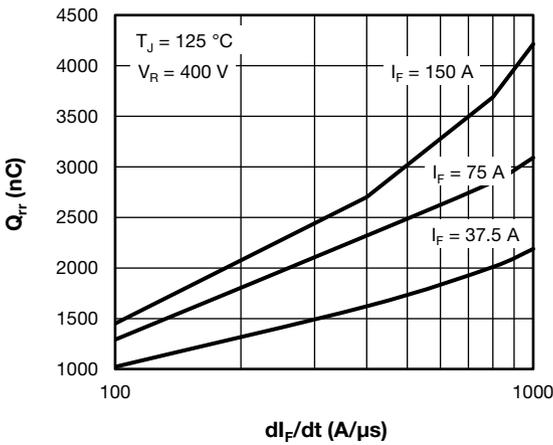


Fig. 8 - Typical Reverse Recovery Charge vs. di_F/dt

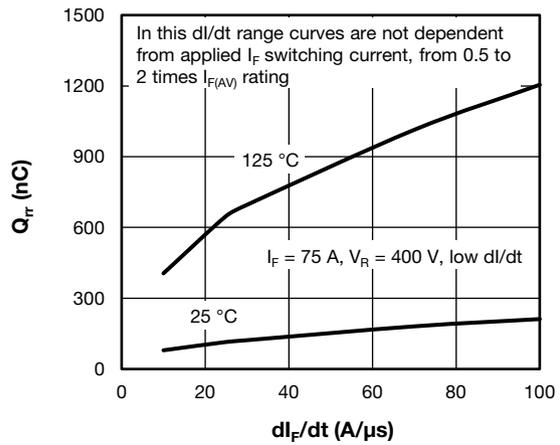


Fig. 11 - Typical Reverse Recovery Charge vs. di_F/dt

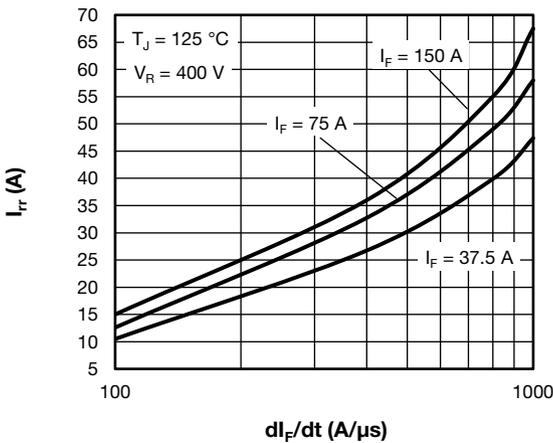


Fig. 9 - Typical Reverse Recovery Current vs. di_F/dt

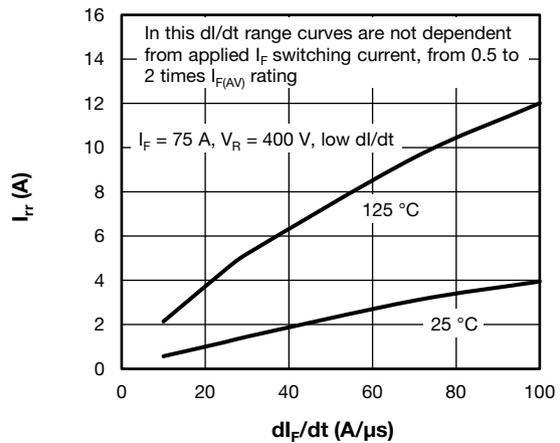
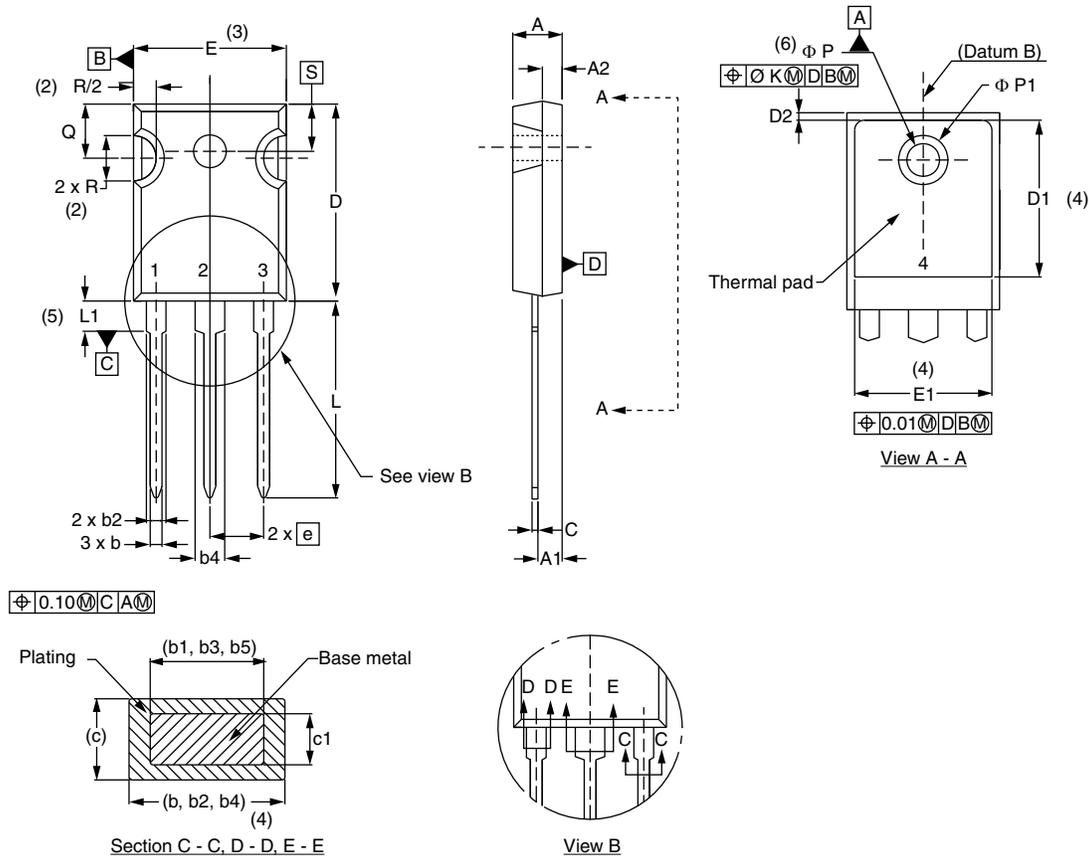


Fig. 12 - Typical Reverse Recovery Current vs. di_F/dt

TO-247AD 3L

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIMETERS | | INCHES | | NOTES | SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | | | MIN. | MAX. | MIN. | MAX. | |
| A | 4.65 | 5.31 | 0.183 | 0.209 | | D2 | 0.51 | 1.30 | 0.020 | 0.051 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | | E | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | | E1 | 13.46 | - | 0.53 | - | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | | e | 5.46 BSC | | 0.215 BSC | | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | | Ø K | 0.254 | | 0.010 | | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | | L | 19.81 | 20.32 | 0.780 | 0.800 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | | L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | | Ø P | 3.56 | 3.66 | 0.14 | 0.144 | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | | Ø P1 | - | 6.98 | - | 0.275 | |
| c | 0.38 | 0.89 | 0.015 | 0.035 | | Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | | R | 4.52 | 5.49 | 0.178 | 0.216 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 | S | 5.51 BSC | | 0.217 BSC | | |
| D1 | 13.08 | - | 0.515 | - | 4 | | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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